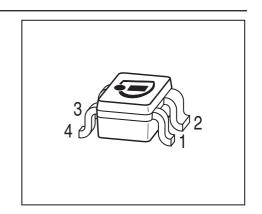


Low Noise Silicon Bipolar RF Transistor

- For high gain and low noise amplifiers
- Minimum noise figure NF_{min} = 1.1 dB at 1.8 GHz Outstanding G_{ms} = 21 dB at 1.8 GHz
- For oscillators up to 10 GHz
- Transition frequency f_T = 25 GHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available







ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package			
BFP420	AMs	1=B	2=E	3=C	4=E	-	-	SOT343

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}		V
T _A = 25 °C		4.5	
<i>T</i> _A = -55 °C		4.1	
Collector-emitter voltage	V _{CES}	15	
Collector-base voltage	V_{CBO}	15	
Emitter-base voltage	V_{EBO}	1.5	
Collector current	$I_{\mathbb{C}}$	60	mA
Base current	I_{B}	9	
Total power dissipation ¹⁾	P _{tot}	210	mW
<i>T</i> _S ≤ 98 °C			
Junction temperature	T_{J}	150	°C
Storage temperature	T _{Stg}	-55 150	

 $^{^{1}}T_{\mathrm{S}}$ is measured on the emitter lead at the soldering point to the pcb

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	250	K/W



Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	•	•		•	•
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	4.5	5	-	V
$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$, ,				
Collector-emitter cutoff current	I _{CES}	-	-	10	μΑ
$V_{CE} = 15 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	3	μΑ
$V_{\rm EB} = 0.5 \text{V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	60	95	130	-
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 4 V, pulse measured					

 $^{^{1}}$ For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)				
Transition frequency	f _T	18	25	-	GHz
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 3 V, f = 2 GHz					
Collector-base capacitance	C _{cb}	-	0.15	0.3	pF
$V_{CB} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.37	-	
$V_{CE} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	0.55	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,					
collector grounded					
Minimum noise figure	NF _{min}	-	1.1	-	dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 2 V, f = 1.8 GHz, $Z_{\rm S}$ = $Z_{\rm Sopt}$					
Power gain, maximum stable ¹⁾	G _{ms}	-	21	-	dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
$Z_{L} = Z_{Lopt}$, $f = 1.8 \text{ GHz}$					
Insertion power gain	$ S_{21} ^2$	14	17	-	
$V_{CE} = 2 \text{ V}, I_{C} = 20 \text{ mA}, f = 1.8 \text{ GHz},$					
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$					
Third order intercept point at output ²⁾	IP3	-	22	-	dBm
$V_{CE} = 2 \text{ V}, I_{C} = 20 \text{ mA}, f = 1.8 \text{ GHz},$					
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$					
1dB compression point at output	P _{-1dB}	-	12	-	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 1.8 GHz					

 $^{^{1}}G_{ms} = |S_{21} / S_{12}|$

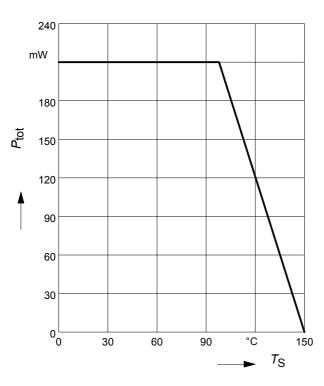
²IP3 value depends on termination of all intermodulation frequency components.

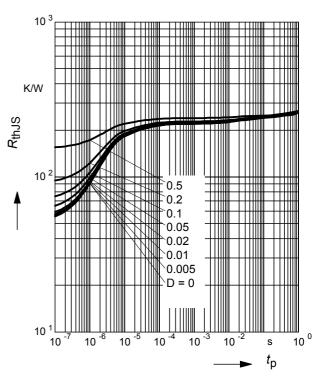
Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz



Total power dissipation $P_{tot} = f(T_S)$

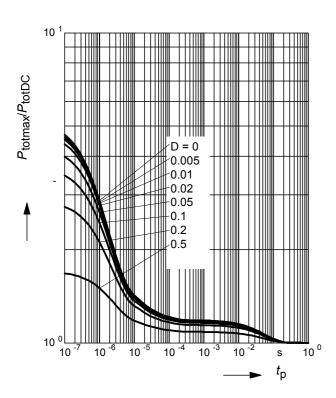
Permissible Pulse Load $R_{thJS} = f(t_p)$



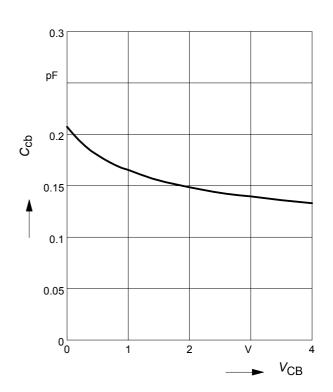


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$



Collector-base capacitance C_{cb} = $f(V_{CB})$ f = 1MHz

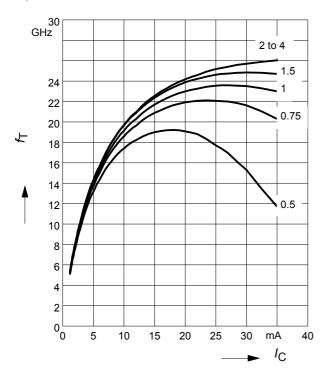




Transition frequency $f_T = f(I_C)$

f = 2 GHz

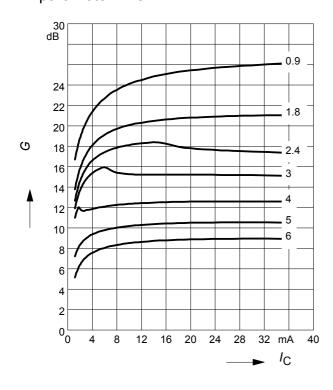
 V_{CE} = parameter in V



Power gain G_{ma} , $G_{ms} = f(I_C)$

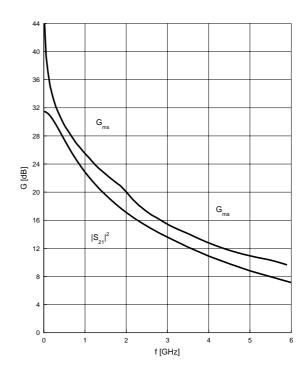
 $V_{CE} = 2V$

f = parameter in GHz



Power gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$

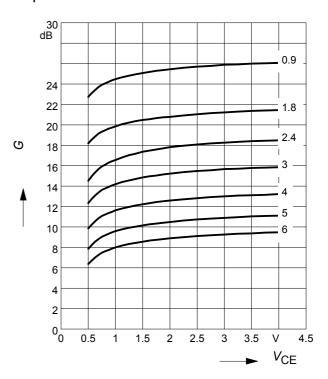
 $V_{CE} = 2 \text{ V}, I_{C} = 20 \text{ mA}$



Power gain G_{ma} , $G_{ms} = f(V_{CE})$

 $I_{\rm C}$ = 20 mA

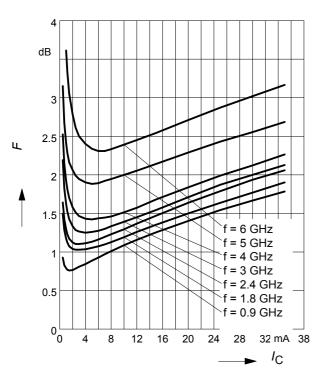
f = parameter in GHz





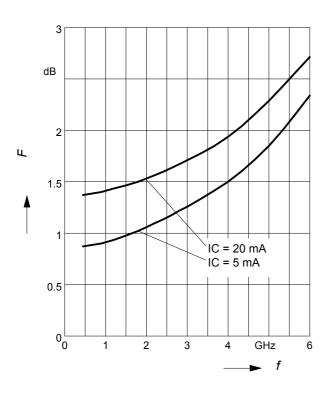
Noise figure $F = f(I_C)$

 V_{CE} = 2 V, Z_{S} = Z_{Sopt}



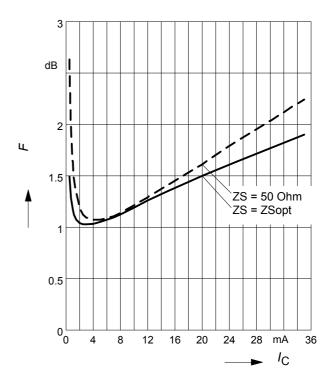
Noise figure F = f(f)

$$V_{CE}$$
 = 2 V, Z_{S} = Z_{Sopt}



Noise figure $F = f(I_C)$

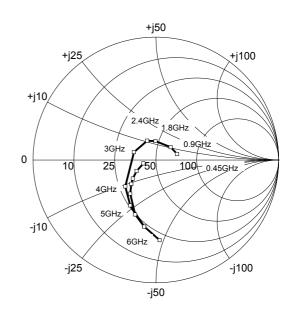
 $V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz}$



Source impedance for min.

noise figure vs. frequency

 $V_{\rm CE}$ = 2 V, $I_{\rm C}$ = 5 mA / 20 mA





SPICE GP Model

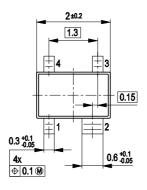
For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website www.infineon.com/rf.models.

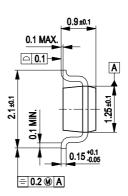
Please consult our website and download the latest versions before actually starting your design. You find the BFP420 SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device. The model parameters have been extracted and verified up to 10 GHz using typical devices. The BFP420 SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.



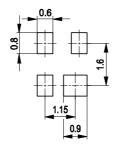
Package Outline



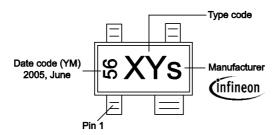




Foot Print

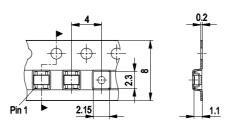


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





Edition 2009-12-02 Published by Infineon Technologies AG 85579 Neubiberg, Germany © Infineon Technologies AG 2009. All Rights Reserved.

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system.

Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

BFP 420 E6740 BFP 420 H6327 BFP 420 H6433 BFP 420 H6740 BFP 420 H6801 BFP 420 E6433 BFP 420 E6327 BFP420H6327XTSA1